

- High Q at high frequencies
- Stable COG temperature coefficient
- Ultra-Miniature Size
- Highly Reliable Performance
- High RF Power handling capabilities
- Industry Standard Size
- Tape & Reel for Surface Mount Assembly

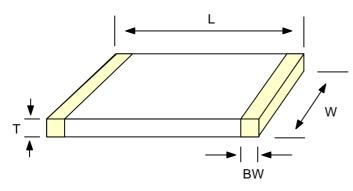
PART NUMBER CODE

<u>CL</u>	<u>10</u>	<u>C</u>	<u>101</u>	<u>J</u>	<u>B</u>	<u>G</u>	<u>C</u>
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)

- (1) SAMSUNG Multilayer Ceramic Chip Capacitor
- (2) Type(Size)
- (3) Capacitance Temperature Characteristics
- (4) Nominal Capacitance
- (5) Capacitance Tolerance
- (6) Rated Voltage
- (7) code " G " : Cu Inner electrode
 - code "C": Ni Inner electrode
- (8) Packaging Type



CONFIGURATION AND DIMENSIONS



CODE	EIA CODE		DIMENSION (mm)									
CODE		L	w	T (MAX)	BW							
05	0402	1.0 +/- 0.05	0.5 +/- 0.05	0.5 +/- 0.05	0.2 +0.15/-0.1							
10	0603	1.6 +/- 0.1	0.8 +/- 0.1	0.8 +/- 0.1	0.3 +/- 0.2							

CAPACITANCE TEMPERATURE CHARACTERISTIC

@ CLASS I (Temperature Compensation)

Symble	EIA Code	Temperature Coefficient(PPM/C)	Operation Temperature Range
С	C0G(CH)	0 +/- 60	-55 ~ +125C

@ CLASS II (High Dielectric Constant)

Symble	EIA Code	Capacitance Change (△ C : %)	Operation Temperature Range
В	X7R	+/- 15	-55 ~ +125C

NOMINAL CAPACITANCE

The value of nominal capacitance is expressed in pico-Farad(pF) with a three-digit number. The first two digits denote significant figures and the last digit denotes the multiple of 10 in pF. For values below 1pF, the letter "R" is used as the decimal point and the last digit becomes significant.

example $100 = 10 \times 10^{\circ}0 = 10 \text{ pF}$ $222 = 22 \times 10^{\circ}2 = 2200 \text{ pF}$ $020 = 2 \times 10^{\circ}0 = 2 \text{ pF}$ 1R5 = 1.5 pF



CAPACITANCE TOLERANCE

Temperature Characteristics	Symbol	Tolerance	Applicable Capacitance & Range				
	В	+/- 0.1pF					
	С	+/- 0.25pF	Loss than 10pE				
C0G(NPO)	D	+/- 0.5pF	Less than 10pF				
or	F	+/- 1.0pF					
T.C Series	*G	+/- 2%					
	J	+/- 5%	E-24 Series for over 10pF				
	К	+/- 10%					
	J	+/- 5%					
B(X7R)	К	+/- 10%	E-12 Series				
	М	+/- 20%					

Please Consult us for special tolerances. *: Option

RATED VOLTAGE

Symble	Rated Voltage(Vdc)	Symble	Rated Voltage(Vdc)
Q	6.3V	Α	25V
Р	10V	В	50V
0	16V	С	100V

PACKAGING TYPE

Symbol	Packaging	Symbol	Packaging
В	Bulk	0	Cardboard Tape, 10" Reel
Р	Cassette	D	Cardboard Tape, 13" Reel
С	Cardboard Tape, 7" Reel	L	Cardboard Tape, 13" Reel

STANDARD CAPACITANCE STEP

Series		Capacitance Step											
E- 3		1	.0			2.2				4.7			
E- 6	1.0 1.5		2	.2	3.3		4.7		6.8				
E-12	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2	
F 04	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2	
E-24	1.1	1.3	1.6	2.0	2.4	3.0	3.6	4.3	5.1	6.2	7.5	9.1	

Standard Capacitance is " Each step x 10^n "



CAPACITANCE RANGE

Temp.	Inner				Capacitance Range (pF)							
Charact -eristics	Electrode	Size	Voltage	10)	100		0 1000		10000		
COG	Cu	05 (0402) 10 (0603)	6.3V ~ 100V	0.3		3						
(N P O)	N i 05 (0402) 10	(0402)	6.3V ~ 100V		33 33		100 100					
Х7R (В)	Ni	05 (0402) 10 (0603)	6.3V ~ 50V				20				10000 10000	

ADVANTAGE OF LOW LOSS CAPACITOR

- Extended battery life
- Increase power output and higher efficiency from RF power amplifiers
- Reduce the amount of heat generated
- The signal to noise ratio and overall noise temperature can easily be improved
- Designing low loss ceramic capacitors into filter networks will minimize

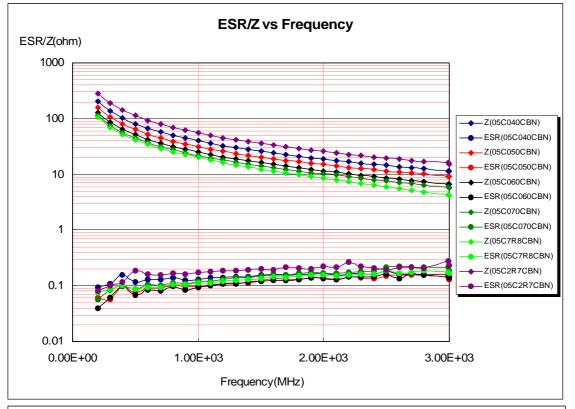
the band(S21) insertion loss

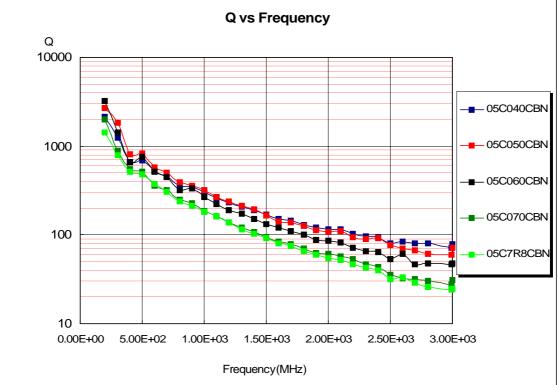
APPLICATIONS

- Cellular base station equipment
- High Q frequency sources
- Broadband wireless services
- Satcom equipment
- Point-to-Point/Point-to-Multipoint Radio
- Cellular phone
- RF LAN
- VCO
- TCXO
- Filter Networks
- Matching Networks
- Tuning, Coupling, Bypass and DC Block
- MRI
- MMICs
- LNA(Low noise amplifier)



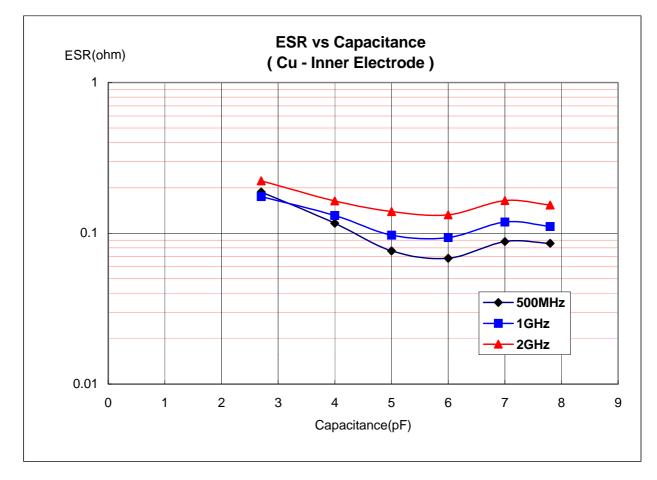
TYPICAL ELECTRIC CHARACTERISTICS







TYPICAL ELECTRIC CHARACTERISTICS





RELIABILITY AND TEST CONDITIONS

NO	ITEM			PERI	FORMA	NCE		TE	ST CONDITIO	N		
1	APPEARAN	ICE	NO ABI	NORMAL RANCE	EXTERI	IOR		THROUGH MICROS	THROUGH MICROSCOPE(x10)			
2	INSULATIC RESISTAN		PRODU (RATED	lohm OR CT WHIC VOLTAC Mohm C	CHEVER GE IS B	IS SMA ELOW 1	6V	RATED VOLTAGE SHALL BE APPLIED. MEASUREMENT TIME IS 60 ~ 120 RATED VOLTAGE TIME 60 SEC.				
3	WITHSTANE VOLTAG		-	LECTRIC NICAL B			OR	CLASS I: 300% OF THE RATED VOLTAGE FOR 1~5 SEC, CLASS II:250% OF THE RATED VOLTAGE FOR 1~5 SEC IS APPLIED WITH LESS THAN 50mA CURRENT				
								CAPACITANCE	FREQUENCY	VOLTAGE		
		CLASS		HIN THE		FIED		1,000pF AND BELOW	1MHz+/-10%	0.5. 5. Virus		
4					_			MORE THAN 1,000pF	1KHz+/-10%	0.5 ~ 5 Vms		
								CAPACITANCE	FREQUENCY	VOLTAGE		
		CLASS		HIN THE		FIED		22uF AND BELOW	1KHz+/-10%	1.0+/-0.2Vrms		
					-			MORE THAN 22uF	120Hz+/-20%	0.5+/-0.1Vrms		
								CAPACITANCE	FREQUENCY	VOLTAGE		
5	Q	CLASS		30pF:Q HAN 30p)C	1,000pF AND BELOW	1MHz+/-10%			
				(C : C	APACIT	ANCE)		MORE THAN 1,000pF		0.5 ~ 5 Vrms		
								CAPACITANCE	FREQUENCY	VOLTAGE		
				25V	4014	4.614		22uF AND BELOW	1KHz+/-10%	1.0+/-0.2Vrms		
6	Tan delta	CLASS	Char.	and over	16V	10V	6.3V	MORE THAN 22uF	120Hz+/-20%	0.5+/-0.1Vrms		
		II	В	0.025 MAX	0.035 MAX	0.05 MAX	0.05 MAX					
7	ADHESIVE STRENGTH NO INDICATION OF PEELING SHALL OF TERMINATION OCCUR ON THE TERMINAL ELECTRODE.				A 500g.f PRESSURI		00g.f					



NO	П	EM	PE	RFORM	IANCE	TEST CONDITION		
		APPEARANCE	NO MECHAN OCCUR.	NICAL DA	AMAGE SHALL	BENDING SHALL BE APPLIED TO THE LIMIT(1mm) WITH 0.3mm/SE .20 .		
	BENDING		CHARAC	CTER	CHANGE OF CAPACITANCE	5 <u>0</u>		
8	STRENGTH	CAPACITANCE	CLASS I		WITHIN +/-5% OR +/- 0.5 pF WHICHEVER IS LARGER			
			CLASS II	B(X7R)	WITHIN +/-12.5%			
9	SOLDE	SURFACE IS	S TO BE PART(A)	F THE TERMINAL SOLDERED NEWLY, DOES NOT COME	SOLDER TEMPERATURE : 230+/-5C SOLDER : H63A FLUX : ROSIN PRE-HEATING : AT 80~120C FOR 10~30SEC.			
		APPEARANCE		ECHANIC	CAL DAMAGE	DIP : SOLDER TEMPERATURE OF 270+/-5C DIP TIME : 10+/-1 SEC. EACH TERMINATION SHALL BE FULLY		
			CHARACTE	RISTIC	CAP. CHANGE			
		CAPACITANCE	CLASS	; 1	WITHIN +/-2.5% OR +/-0.25pF WHICHEVER IS LARGER	IMMERSED AND PREHEATED		
10	RESISTANCE TO		CLASS	В	WITHIN +/-7.5%	STEP TEMP.(C) (SE	C.)	
	SOLDERING HEAT	Q CLASS I	30pF AND C LESS THAN		Q>= 1000 Q>= 400+20xC	1 80~100 60 2 150~180 60		
		Tan delta CLASS II	TO SATISFY		PECIFIED	MEASURE AT ROOM TEMP. AFT	ER	
		INSULATION RESISTANCE	TO SATISFY		PECIFIED	CLASS I : 24 +/- 2 HOURS CLASS II : 48 +/- 4 HOURS		
		WITHSTANDING VOLTAGE	TO SATISFY		PECIFIED			



NO	ľ	TEM		PERF	ORMAN	ICE		TEST CONDITION		
		APPEARANCE	NO MECHAN	ICAL D	AMAGE	SHALL O	CCUR.	THE CAPACITOR SHALL BE		
			CHARACTER	ISTIC	C/	AP. CHAN	IGE	SUBJECTED TO A HARMONIC MOTION		
		CAPACITANCE	CLASS	+/-0.25p	WITHIN +/-2.5% OR +/-0.25pF WHICHEVER IS LARGER		HAVING A TOTAL AMPLITUDE OF 1.5mm.			
11	VIBRATION		CLASS II B		WITHIN	l +/-5%		THE ENTIRE FREQUENCY RANGE, FROM 10 TO 55Hz AND RETURN TO 10Hz, SHALL BE TRAVERSED		
	TEST	Q CLASS I	30pF AND O LESS THAN					IN 1 MINUTE.		
		Tan delta CLASS II	TO SATISFY		SPECIFIE	D		THIS CYCLE SHALL BE PERFORMED 2 HOURS IN EACH THERE MUTUALLY		
		INSULATION RESISTANCE	TO SATISFY		SPECIFIE	D	PERPENDICULAR DIRECTION, FOR TOTAL PERIOD OF 6 HOURS.			
		APPEARANCE	NO MECHAN	ICAL D	AMAGE	SHALL O				
			CHARACTERISTIC CAPA CH							
		CAPACITANCE	CLASS	WITHIN +/-5% OR +/-0.5pF WHICHEVER IS LARGER			TEMPERATURE : 40+/-2 C RELATIVE HUMIDITY : 90~95 %RH			
			CLASS B			WITHIN +/-12.5%		TEST TIME : 500 +12/-0 Hr.		
12	HUMIDITY (STEADY	Q CLASS I	30pF AND O 10 ~30pF LESS THAN	: Q>=	275 + 2	.5xC		MEASURE AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24+/-2 Hr.		
	STATE)							CLASS II : 48+/-4 Hr.		
		Tan delta	Char. 25V ov		16V	10V	6.3V			
		CLASS II	B 0.05 MAX		0.06 MAX	0.75 MAX	0.075 MAX			
		INSULATION RESISTANCE	MINIMUM INS 1,000 Mohm WHICHEVER	OR 501	<i>l</i> ohm uF		T			

* THE INITIAL VALUE OF HIGH DIELECTRIC CONSTANT SERIES SHALL BE MEASURED AFTER THE HEAT TREATMENT OF 150 +0/-10C, 1Hr AND SITTING OF 48+/-4hr AT ROOM TEMPERATURE & ROOM HUMIDITY.



Multilayer Chip Capacitors – High Frequency

NO	ITEM		PERFORMANCE					TEST CONDITION			
13	MOISTUR E RESISTANCE	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR CHARACTERISTIC CHANGE				APPLIED VOLTAGE : RATED VOLTAGE				
		CAPACITANCE	CL	ASS I	+/-0.7	N +/-7.5% 5pF WHIC RGER	OR	TEMPERATURE : 40+/-2 C RELATIVE HUMIDITY : 90-95%RH			
			CLASS B		WITHI	N +/-12.5%	6	TEST TIME : 500 +12/-0 Hr.			
		Q CLASS I	30pFAND OVER : Q>= 200 30pF AND BELOW : Q>= 100 + 10/3xC				CURRENT APPLIED : 50mA MAX.				
		Tan delta CLASS II	Char.	25V and over	16V	10V	6.3V	MEASURING AT ROOM TEMPERATURE AFTER COOLING FOR			
			в	0.05 MAX	0.06 MAX	0.075 MAX	0.075 MAX				
		INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 500 Mohm OR 25Mohm uF PRODUCT, WHICHEVER IS SMALLER.					CLASS I : 24+/-2 Hr. CLASS II : 48+/-4 Hr.			
	HIGH TEMPERATURE RESISTANCE	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR				APPLIED VOLTAGE : 200% OF RATED VOLTAGE TEST TIME : 1000 +48/-0 Hr.				
		CAPACITANCE	CHARACTERISTIC CAP. CHANGE								
			CL	ASS I		N +/-3% (oF, WHICH ER		CURRENT APPLIED : 50mA MAX.			
			CLASS II	В	WITH	N +/-12.5%	6	CHAR. CLASS I	TEMP. 125 +/-3 C		
14		Q CLASS I	30pF AND OVER : Q >= 350 10 ~ 30 pF : Q >= 275 + 2.5xC LESS THAN 10pF :Q >=200 + 10xC				CLASS B	125 +/-3 C			
		Tan delta CLASS II	Char.	25V and over	16V	10V	6.3V	(INITIAL VALUE MEASUREMENT) FOR CLASSⅡ CAPACITORS, 200 %			
			в	0.05 MAX	0.06 MAX	0.075 MAX	0.075 MAX	OF RATED VOLTAGE SHALL BE APPLIED FOR 1 HOUR AT THE			
		INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 1,000 Mohm OR 50Mohm uF PRODUCT WHICHEVER IS SMALLER				MAXIMUM OPERATING TEMPERATURE, THEN KEEP IT AT ROOM TEMPERATURE. FOR 48 +/- 4 Hrs.				



Multilayer Chip Capacitors – High Frequency

NO	ITEM			PERF	ORMANCE	TEST CONDITION			
15	TEMPERATURE CYCLE	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR			CAPACITORS SHALL BE SUBJECTED			
		CAPACITANCE	CHARACTI	ERISTIC	CAP. CHANGE	TO FIVE CYCLES OF THE			
			CLASS I		WITHIN +/-2.5% OR +/-0.25pF	TEMPERATURE CYCLE AS FOLLOWING			
					WHICHEVER IS LARGER	STEP	TEMP.(C)	TIME (MIN)	
			CLASS II	В	WITHIN +/-7.5%	1	MIN. RATED TEMP.	30	
		Q	30 pF AND OVER : Q >= 1000 LESS THAN 30pF:Q >=400 +20xC				+0/-3		
		CLASS I				2	25	2~3	
		Tan delta CLASS II	TO SATISF		SPECIFIED	3	MAX. RATED TEMP. +3/-0	30	
						4	25	2~3	
		INSULATION RESISTANCE	TO SATISFY THE SPECIFIED INITIAL VALUE			MEASURE AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24+/-2 Hr. CLASS II : 48+/-4 Hr.			